

N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a	Q _g (Typ.)			
30	0.0033 at V _{GS} = 10 V	30	37 nC			
30	0.0041 at V _{GS} = 4.5 V	26.3	37 110			

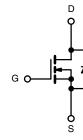
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested

ROHS COMPLIANT HALOGEN FREE Available

APPLICATIONS

- Low-Side DC/DC Conversion
 - Notebook
 - Gaming



N-Channel MOSFET

		SO-8		
s	1		8	D
s	2		7	D
S	3		6	D
G	4		5	D
		Top View	I	

Ordering Information: Si4626ADY-T1-E3 (Lead (Pb)-free)

Si4626ADY-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter Drain-Source Voltage		Symbol	Limit	Unit	
		V _{DS}	30	V	
Gate-Source Voltage		V_{GS}	± 20	v	
	T _C = 25 °C		30		
Continuous Drain Current (T _{.I} = 150 °C)	T _C = 70 °C	I _D	22.6		
Continuous Brain Current (1) = 150 °C)	T _A = 25 °C	'b	21.5 ^{b, c}		
	T _A = 70 °C		17.1 ^{b, c}	Α	
Pulsed Drain Current		I _{DM}	70	A	
Ocation of Community Division Community	T _C = 25 °C	1-	5.4		
Continuous Source-Drain Diode Current	T _A = 25 °C	ls –	2.7 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	40		
Avalanche Energy	L=0.11IIII	E _{AS}	80	mJ	
	T _C = 25 °C		6.0		
Maximum Power Dissipation	T _C = 70 °C	P _D	3.3	w	
	T _A = 25 °C	1 'b	3.0 ^{b, c}	VV	
	T _A = 70 °C		1.9 ^{b, c}		
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R_{thJA}	33	42	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	16	21	S/ VV		

Notes:

- a. Based on T_C = 25 °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 85 $^{\circ}\text{C/W}.$

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	30			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050A		37		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I _D = 250 μA		- 7.3		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	1.2		2.5	٧
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zawa Cata Waltana Duain Courset	-	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			1	μΑ
Zero Gate Voltage Drain Current	I _{DSS}				10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α
		V _{GS} = 10 V, I _D = 15 A		0.0026	0.0033	Ω
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 10 A		0.0032	0.0041	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		85		S
Dynamic ^b				l		
Input Capacitance	C _{iss}			5370		
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		690		pF
Reverse Transfer Capacitance	C _{rss}	30 0.0		330		
•	Qg	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 10 A		82	125	
Total Gate Charge				37	56	
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		12.6		
Gate-Drain Charge	Q _{gd}			9.8		
Gate Resistance	R_g	f = 1 MHz	0.2	0.95	1.9	Ω
Turn-On Delay Time	t _{d(on)}			44	70	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_L = 3 \Omega$		21	35	-
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		45	70	
Fall Time	t _f			18	30	
Turn-On Delay Time	t _{d(on)}			15	30	ns
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 3 \Omega$		10	20	_
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		43	70	
Fall Time	t _f	1		8	15	
Drain-Source Body Diode Characteristi	cs					
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			5.4	
Pulse Diode Forward Current ^a	I _{SM}	-			70	A
Body Diode Voltage	V _{SD}	I _S = 2.7 A		0.74	1.1	V
Body Diode Reverse Recovery Time	t _{rr}	-		38	60	ns
Body Diode Reverse Recovery Charge	Q _{rr}	† . <u>. .</u>		36	60	nC
Reverse Recovery Fall Time	t _a	$I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		20		+ -
Reverse Recovery Rise Time	t _b			18		ns

Notes:

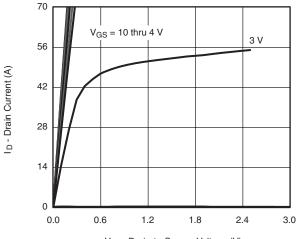
- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



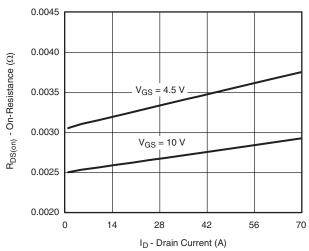
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

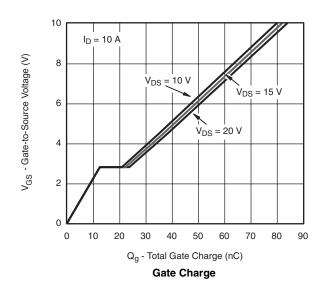


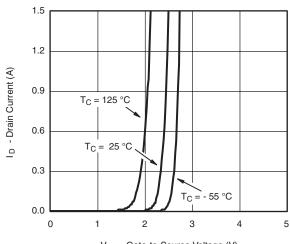
V_{DS} - Drain-to-Source Voltage (V)

Output Characteristics

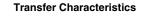


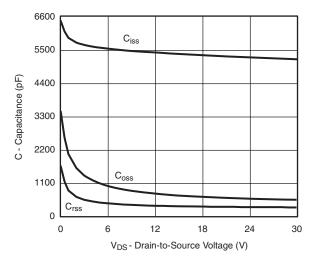
On-Resistance vs. Drain Current and Gate Voltage



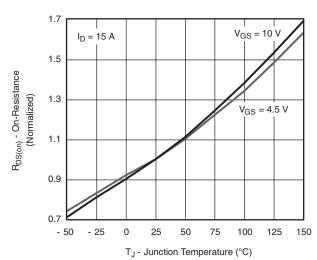


V_{GS} - Gate-to-Source Voltage (V)





Capacitance

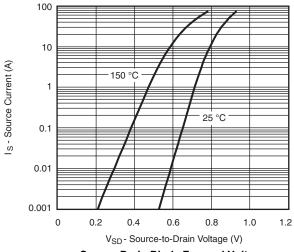


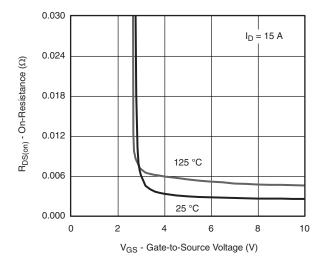
On-Resistance vs. Junction Temperature

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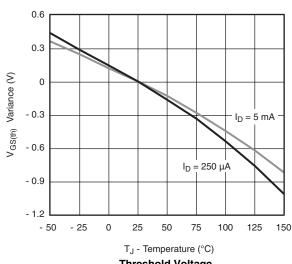
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

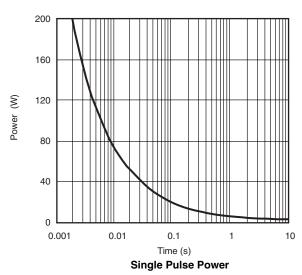




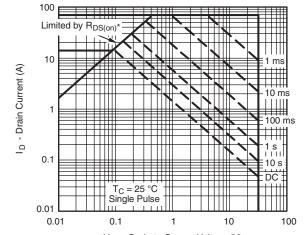
Source-Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage









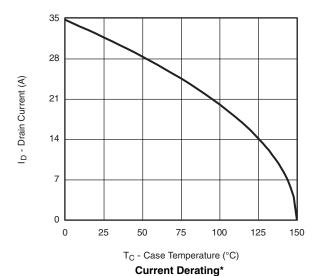
V_{DS} - Drain-to-Source Voltage (V) * V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

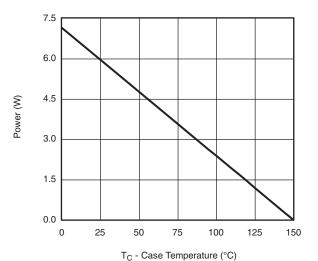
Safe Operating Area, Junction-to-Ambient



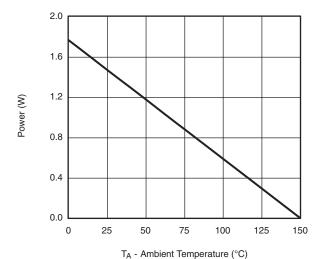
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Power Derating, Junction-to-Foot



Power, Junction-to-Ambient

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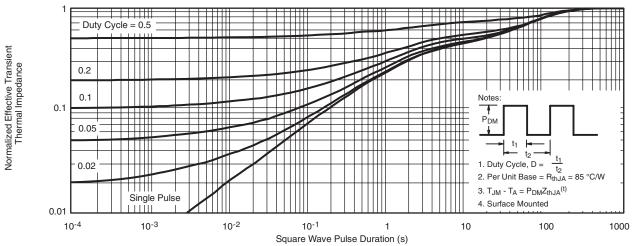
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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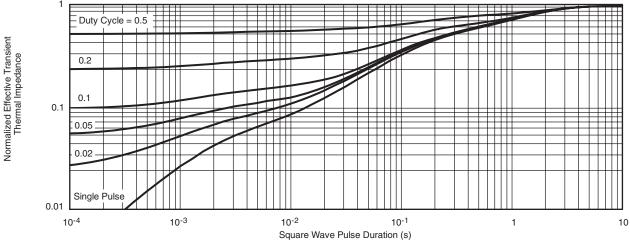
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient

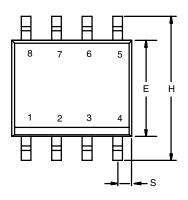


Normalized Thermal Transient Impedance, Junction-to-Foot

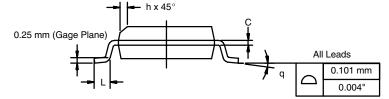
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







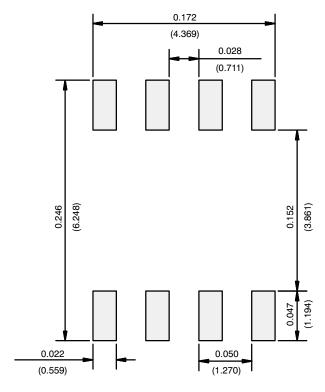
	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOT

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